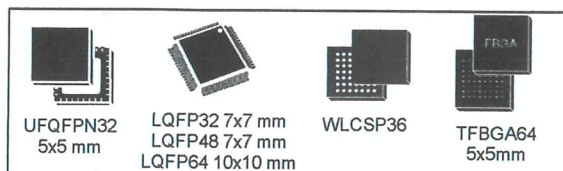


Access line ultra-low-power 32-bit MCU ARM[®]-based Cortex[®]-M0+, up to 64 KB Flash, 8 KB SRAM, 2 KB EEPROM, ADC

Datasheet - production data

Features

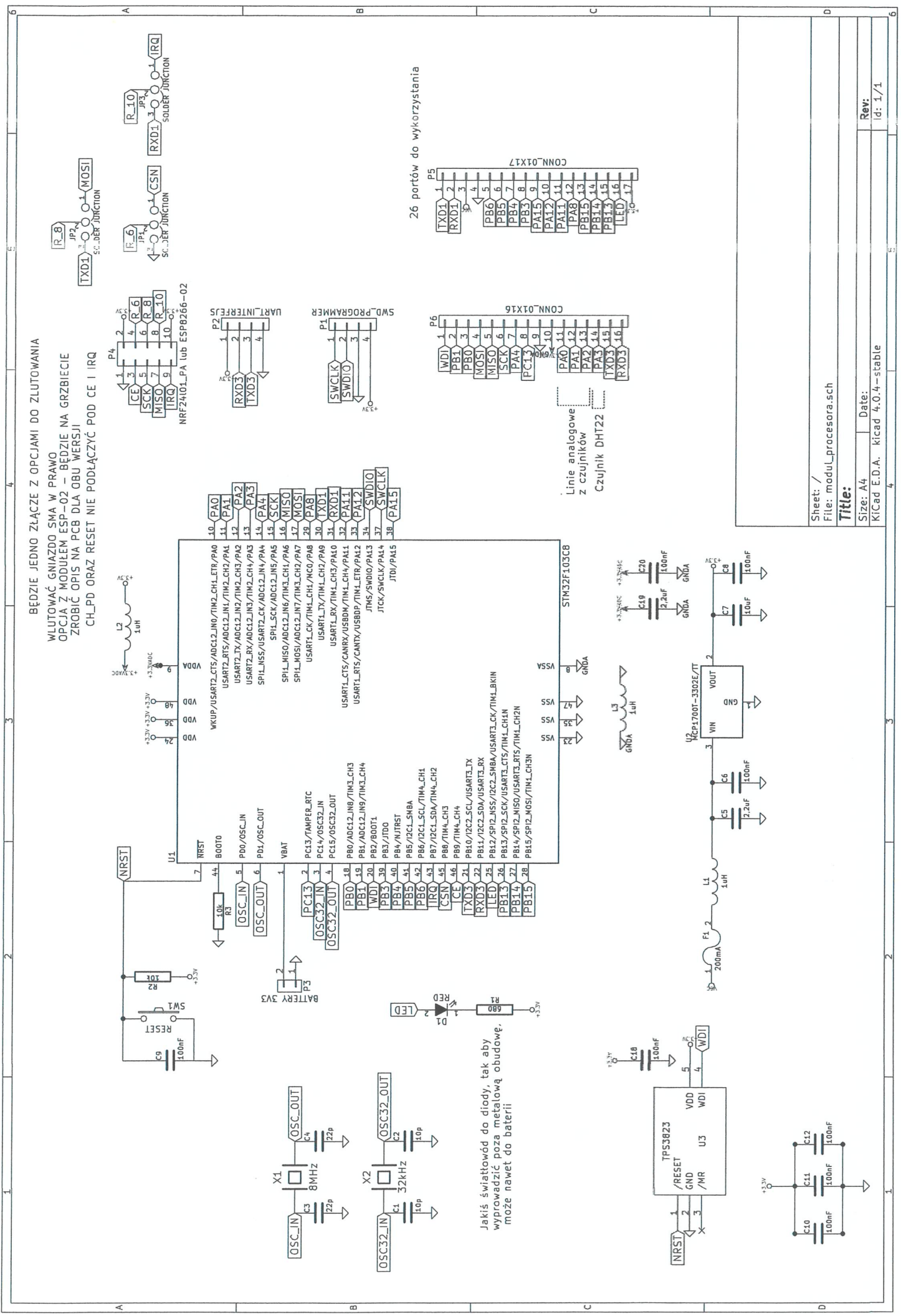
- Ultra-low-power platform
 - 1.65 V to 3.6 V power supply
 - -40 to 125 °C temperature range
 - 0.27 µA Standby mode (2 wakeup pins)
 - 0.4 µA Stop mode (16 wakeup lines)
 - 0.8 µA Stop mode + RTC + 8 KB RAM retention
 - 139 µA/MHz Run mode at 32 MHz
 - 3.5 µs wakeup time (from RAM)
 - 5 µs wakeup time (from Flash)
- Core: ARM[®] 32-bit Cortex[®]-M0+ with MPU
 - From 32 kHz up to 32 MHz max.
 - 0.95 DMIPS/MHz
- Reset and supply management
 - Ultra-safe, low-power BOR (brownout reset) with 5 selectable thresholds
 - Ultralow power POR/PDR
 - Programmable voltage detector (PVD)
- Clock sources
 - 1 to 25 MHz crystal oscillator
 - 32 kHz oscillator for RTC with calibration
 - High speed internal 16 MHz factory-trimmed RC (+/- 1%)
 - Internal low-power 37 kHz RC
 - Internal multispeed low-power 65 kHz to 4.2 MHz RC
 - PLL for CPU clock
- Pre-programmed bootloader
 - USART, SPI supported
- Development support
 - Serial wire debug supported
- Up to 51 fast I/Os (45 I/Os 5V tolerant)
- Memories
 - Up to 64 KB Flash with ECC
 - 8KB RAM
 - 2 KB of data EEPROM with ECC
 - 20-byte backup register
 - Sector protection against R/W operation



- Rich Analog peripherals
 - 12-bit ADC 1.14 Msps up to 16 channels (down to 1.65 V)
 - 2x ultra-low-power comparators (window mode and wake up capability, down to 1.8 V)
- 7-channel DMA controller, supporting ADC, SPI, I2C, USART, Timers
- 7x peripherals communication interface
- 2x USART (ISO 7816, IrDA), 1x UART (low power)
- 2x SPI 16 Mbits/s
- 2x I2C (SMBus/PMBus)
- 9x timers: 1x 16-bit with up to 4 channels, 2x 16-bit with up to 2 channels, 1x 16-bit ultra-low-power timer, 1x SysTick, 1x RTC, 1x 16-bit basic, and 2x watchdogs (independent/window)
- CRC calculation unit, 96-bit unique ID
- All packages are ECOPACK[®]2

Table 1. Device summary

Reference	Part number
STM32L051x6	STM32L051C6
	STM32L051K6
	STM32L051R6
	STM32L051T6
STM32L051x8	STM32L051C8
	STM32L051K8
	STM32L051R8
	STM32L051T8



BĘDZIE JEDNO ZŁĄCZE Z OPCJAMI DO ZŁUTOWANIA
WLUTOWAĆ GNIAZDO SMA W PRAWO
OPCJA Z MODUŁEM ESP-02 – BĘDZIE NA GRZBIECIE
ZROBIĆ OPIS NA PCB DLA OBU WERSJI
CH_PD ORAZ RESET NIE PODŁĄCZYĆ POD CE I IRQ

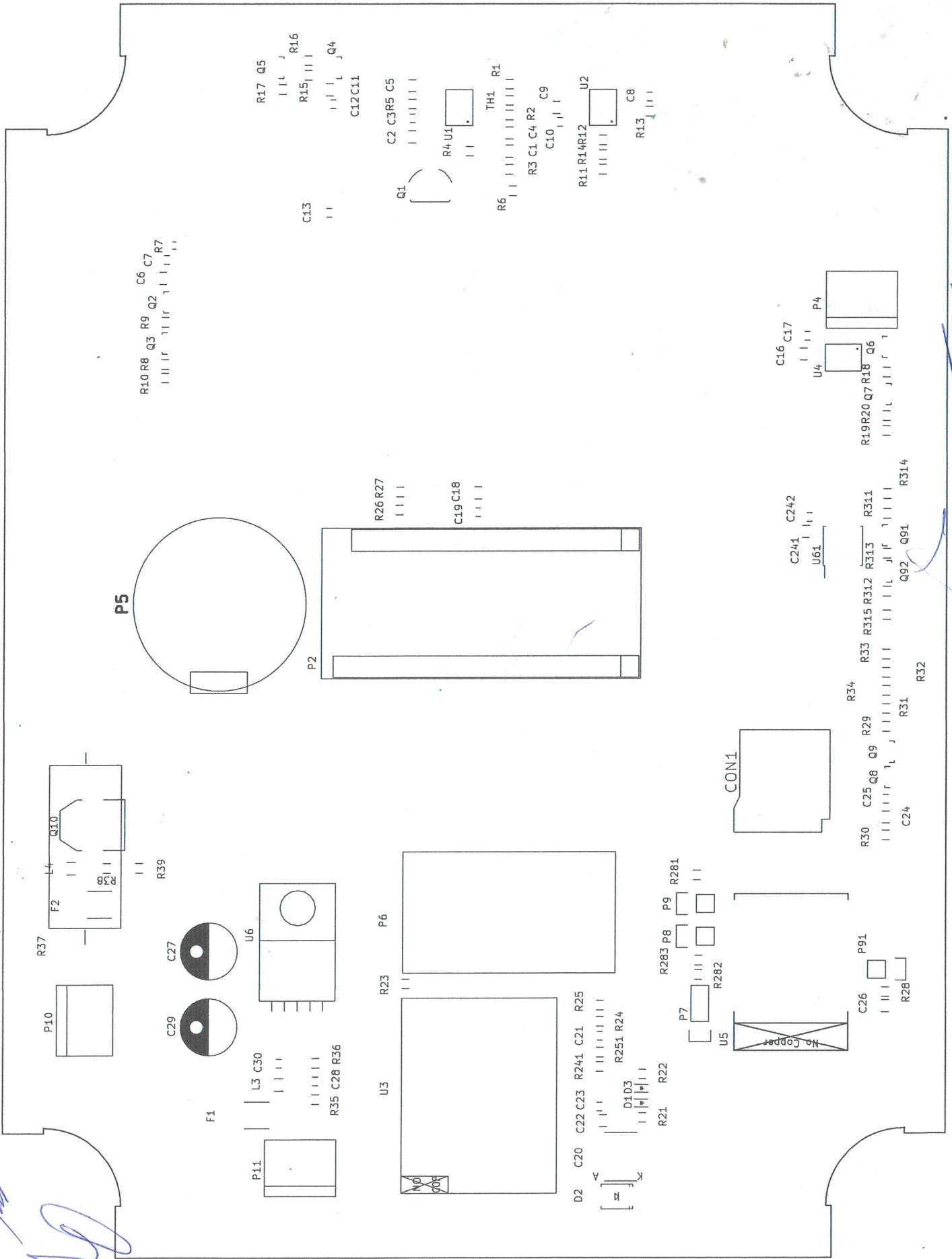
26 portów do wykorzystania

Linie analogowe
z czujników
Czujnik DHT22

Jakis światłowod do diody, tak aby
wyprowadzić poza metalową obudowę.
może nawet do baterii

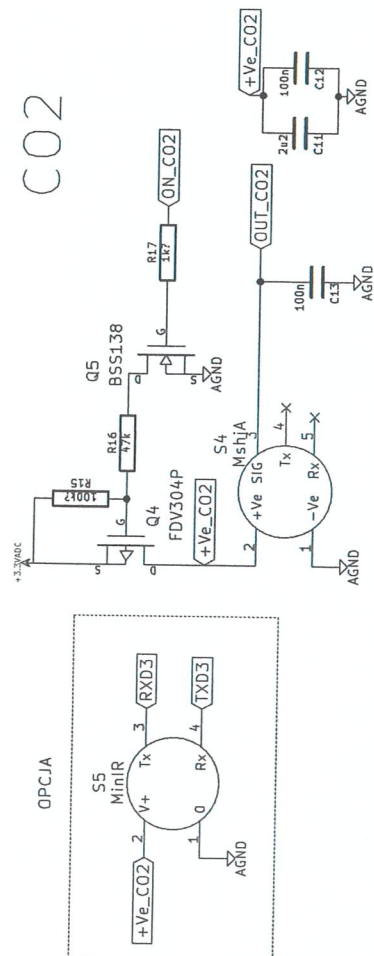
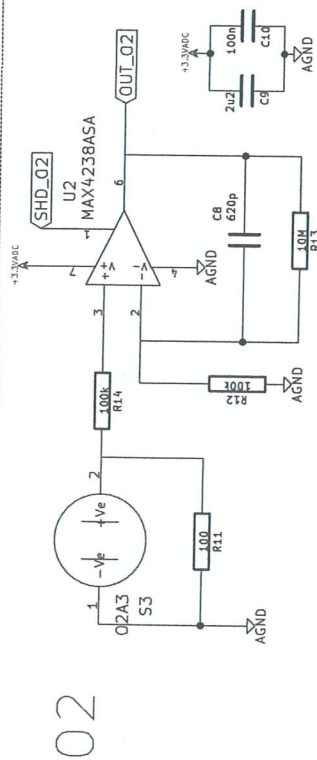
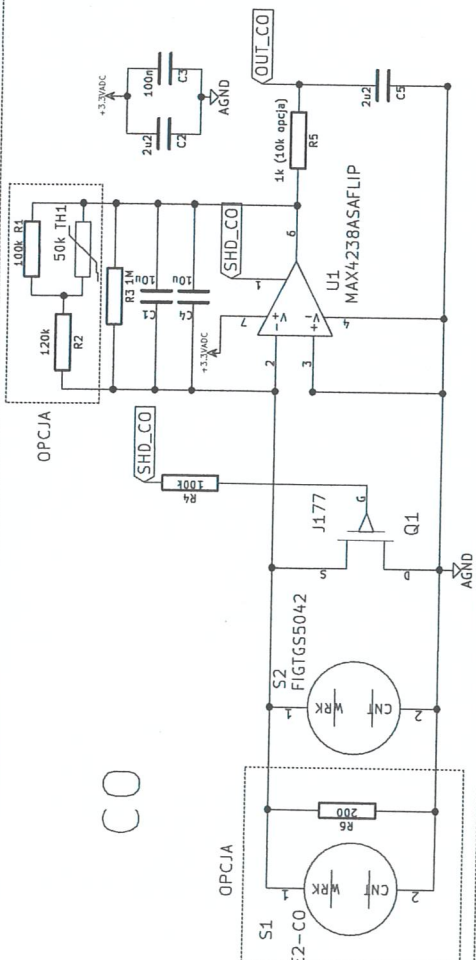
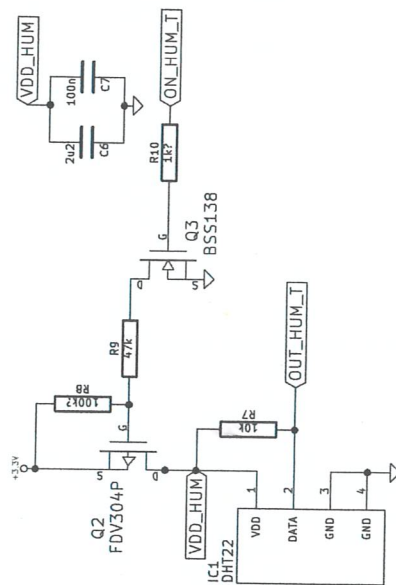
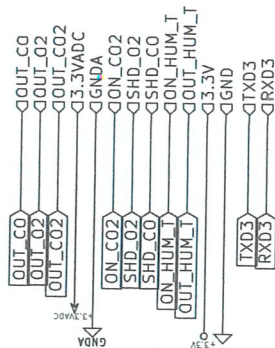
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KiCad E.D.A. kicad 4.0.4–stable
Rev:
Id: 1/1

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Sheet: /sensors/
File: sensors.sch

Title:

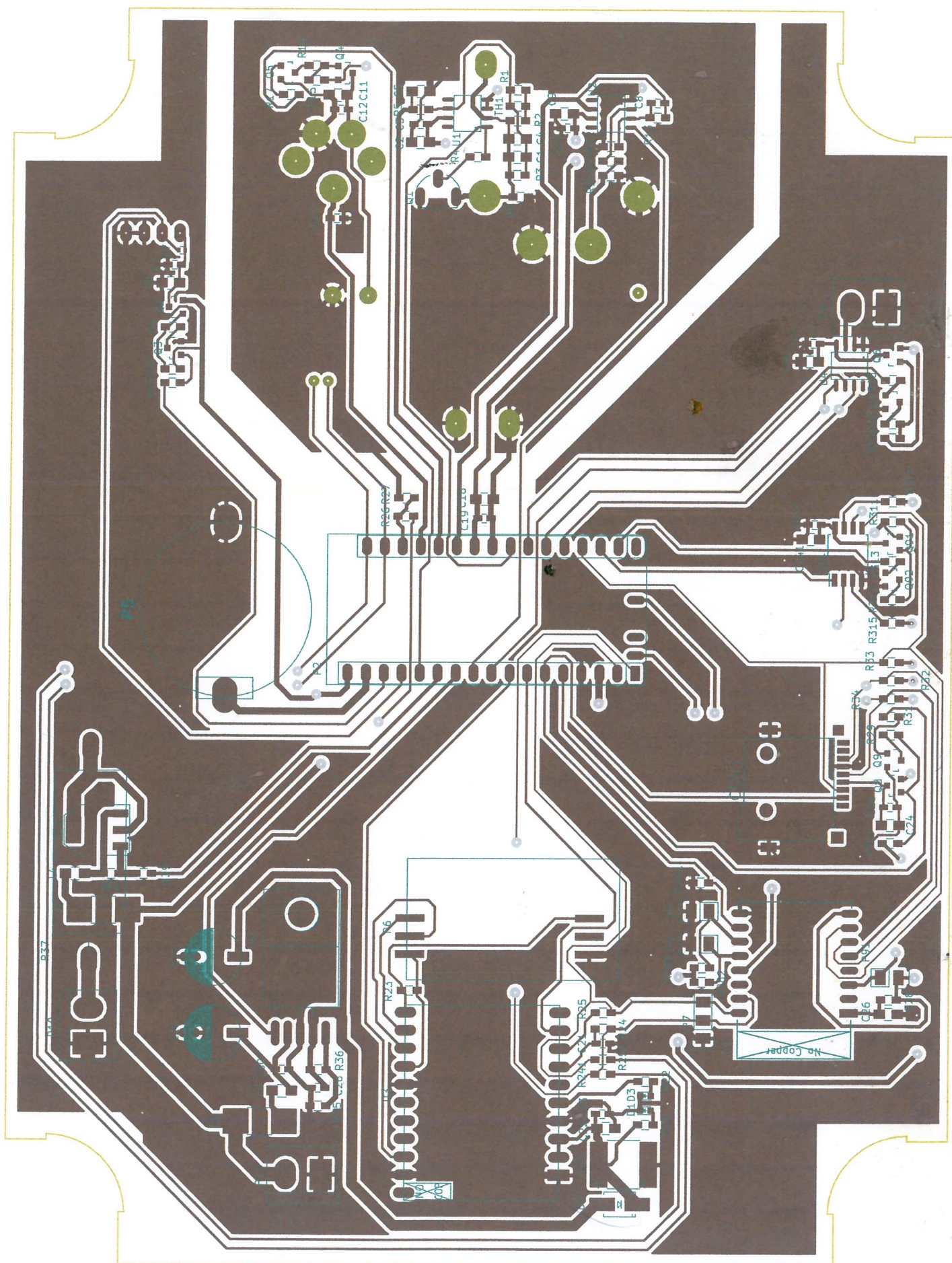
Size: A4

Date: _____

Size: A4	Date:
KiCad E.D.A.	kiCad 4.0.4-stable

Rev:

REV. _____
Id: 2/3



bsp3.0

Oznaczenie	Obudowa	llo-óřá	Oznaczenie
S4	MSHia-P-CO2	1Mshia	
U6	TO-220_5_Horizontal_SMDOTW	1MIC29302	
IC1	DHT22_VERT	1DHT22	
U5	ESP-07V2_SMD	1ESP-07	
R282,R23,R28,R281, R283,R314,R315	R_0603_HandSoldering	710k	
P7	Pin_Header_Straight_1x03_SMD	1ESP_FLASH_UART	
S3	O2-A3	1O2A3	
R13	R_0603_HandSoldering	110M	
S2	TGS5042-A00	1FIGTGS5042	
P2	MODUL_PROC_PINS_17_16_EDGE	1CONN_PROC_EDGE	
U3	m590e	1m590e	
C1,C4	C_0805_HandSoldering	210u	
C2,C5,C6,C9, C11,C16,C24,C241	C_0805_HandSoldering	82u2	
C3,C7,C10,C12, C13,C17,C25,C242	C_0603_HandSoldering	8100n	
C8	C_0603_HandSoldering	1620p	
C18,C22,C26	C_0805_HandSoldering	32.2uF	
C19,C23,C28,C30	C_0603_HandSoldering	4100nF	
C20	C_2225_HandSoldering	11000u	
C21	C_0603_HandSoldering	1100pF	
D1	LED_0603	1LED RED	
D2	SMA_HandSoldering	1D	
D3	LED_0603	1LED GREEN	
F1,F2	R_1812_HandSoldering	22.6A	
L3,L4	R_0805_HandSoldering	21uH	
P4	ZACISK_2_PIN_SMD	1TERMOPARA	
P5	CR2032_SMD	1BATTERY 3V3	
P6	SIM_CARD	1SIM_CARD	
P8	Pin_Header_Straight_1x02_SMD	1ESP_FLASH	
P9	Pin_Header_Straight_1x02_SMD	1ESP_DEBUG	
P10	ZACISK_2_PIN_SMD	1POMPKA	
P11	ZACISK_2_PIN_SMD	1ZASILANIE	
Q1	TO-92-FET-molded-wide-DGS_SMD	1J177	
Q2,Q4,Q6,Q8,Q91	SOT-23_GSD	5FDV304P	
Q3,Q5,Q7,Q9,Q92	SOT-23_GSD	5BSS138	
Q10	SOT-223	1BCP315	
R1,R4,R12,R14, R26,R36,R38	R_0603_HandSoldering	7100k	
R2	R_0603_HandSoldering	1120k	
R3	R_0603_HandSoldering	11M	
R5	R_0603_HandSoldering	11k (10k opcja)	
R6,R21,R22,R24,R25, R241,R251	R_0603_HandSoldering	7	200
R7	R_0402	110k	
R8,R15,R19,R30,R311	R_0603_HandSoldering	5100k?	
R9,R16,R20,R27,R29, R32,R33,R34,R39,R312	R_0603_HandSoldering	1047k	
R10,R17,R18,R31,R313	R_0603_HandSoldering	51k?	
R11	R_0603_HandSoldering	1	100
R35	R_0603_HandSoldering	143k	
S1	ME2-CO	1ME2-CO	

Strona 1

bsp3.0

S5	MINIR		1MinIR
TH1	R_0603_HandSoldering		150k
C27	C_Radial_D8_L11.5_P3.5_SMD		1220u
C29	C_Radial_D8_L11.5_P3.5_SMD		1100u
U1	SO-8		1MAX4238ASAFILIP
U2	SO-8		1MAX4238ASA
U4	SO-8		1MAX6675ISA
R37	Resistor_Horizontal_RM30mm		12R2/1W
CON1	uSD_CARD_SMDPOZ		1uSD_CARD
P91	Pin_Header_Straight_1x02_SMD		1CH_PD_ON
U61	SOIJ-8_5.3x5.3mm_Pitch1.27mm		1S25FL127SABMFI01

Strona 2

modul_procesora

Id	Oznaczenie	Obudowa	Ilość	Oznaczenie
1	P3	CR1225	1	BATTERY 3V3
2	P4	Pin_Header_Straight_2x05	1	NRF24I01_PA lub ESP8266-02
3	JP1,JP2,JP3	SMD-SOLDER_JUNCTION_0805	3	SOLDER JUNCTION
4	U1	LQFP-48_7x7mm_Pitch0.5mm	1	STM32F103C8
5	X1	SMD-5x3.2	1	8MHz
6	U2	SOT-23	1	MCP1700T-3302E/TT
7	C1,C2	C_0402	2	10p
8	C3,C4	C_0402	2	22p
9	D1	LED-0603	1	RED
10	F1	SMD-1812	1	200mA
11	L1,L2,L3	SMD-0805	3	1uH
12	R2,R3	SMD-0402_r	2	10k
13	U3	SOT-23-5	1	TPS3823
14	SW1	TACT_SWITCH_6x2.5mm	1	RESET
15	X2	SMD-0805	1	32kHz
16	C5	SMD-0805	1	2,2uF
17	C6,C8,C9,C10,C11,C12,C18	SMD-0603_c	7	100nF
18	C7	SMD-0805	1	10uF
19	R1	SMD-0603_r	1	680
20	P1	Pin_Header_Surface_1x4	1	SWD_PROGRAMMER
21	P2	Pin_Header_Surface_1x4	1	UART_INTERFEJS
22	C19	C_0402	1	2,2uF
23	C20	C_0402	1	100nF
24	P6	Pin_Header_Straight_1x16	1	CONN_01X16
25	P5	Pin_Header_Straight_1x17	1	CONN_01X17